

3.2 x 1.6 x 0.9mm Red & Pure Green & Blue Chip LED

OSTB1206C1E-A

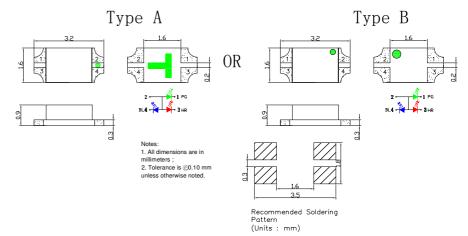
■Features

- Full-Color
- Super high brightness of surface mount LED
- Water Clear Flat Mold
- Compact package outline (LxWxT) of 3.2mm x 1.6mm x 0.9mm
- Compatible to IR reflow soldering.

Applications

Backlighting (switches, keys, etc.)
Marker lights (e.g. steps, exit ways, etc.)

■Outline Dimension

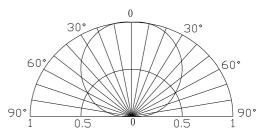


■Absolute Maximum Rating

(T	a=2	25°	C,

Item	Symbo	Val	Unit		
Item	1	R	G/B	Oilit	
DC Forward Current	I_{F}	20	20	mA	
Pulse Forward Current#	I_{FP}	100	100	mA	
Reverse Voltage	V_R	5	5	V	
Power Dissipation	P_{D}	46	66	mW	
Operating Temperature	Topr	-40 ~	$^{\circ}\mathbb{C}$		
Storage Temperature	Tstg	-40~	$^{\circ}\!\mathbb{C}$		
Lead Soldering Temperature	Tsol	260°C /	/10sec	-	

■Directivity



#Pulse width Max 0.1ms, Duty ratio max 1/10

■Electrical -Optical Characteristics

(Ta=25°C)

			V _F (V)			$I_R(\mu A)$	Iv(mcd)		λD(nm)			2θ1/2(deg)		
Part Number	Part Number Color		Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.	
				I _F =5mA			V _R =5V	I _F =5mA						
	Blue	В		-	2.7	3.3	10	30	50	-	460	466	472	120
OSTB1206C1E-A	Pure Green	G		-	2.7	3.3	10	100	150	-	515	520	525	120
	Red	R		-	1.7	2.3	10	30	50	-	615	620	625	120

^{*1} Tolerance of measurements of dominant wavelength is ± 1 nm

ISO 9001: 2008







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^{*2} Tolerance of measurements of luminous intensity is ±15%

^{*3} Tolerance of measurements of forward voltage is±0.1V



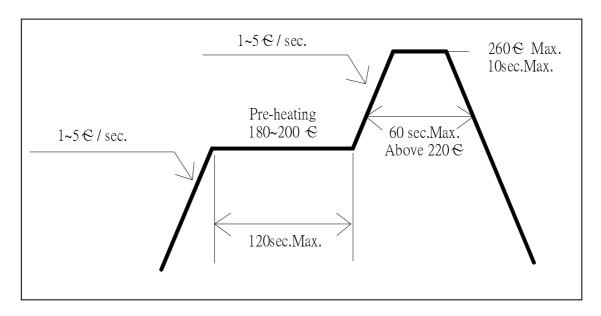
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■ Soldering Conditions

	Reflow Soldering	Har	Hand Soldering			
Pre-Heat	180 ~ 200°C					
Pre-Heat Time	120 sec. Max.					
Peak temperature	260°C Max.	Temperature	350°C Max. 3 sec. Max.			
Dipping Time	10 sec. Max.	Soldering time				
Condition	Refer to Temperature-profile		(one time only)			

• Reflow Soldering Condition(Lead-free Solder)



- *Recommended soldering conditions vary according to the type of LED
- *Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- *A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.









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http://www.optosupply.com VER A.2.1



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■ Cautions:

- 1. After open the package, the LED's floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.







